Surge arrester

3-electrode arrester

Series/Type: TG20-C420SMD6
Ordering code: B88069X5433T203
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Surge arrester

3-electrode arrester

Features

- Very small size
- Very fast response time
- Stable performance over life
- Very low capacitance
- High insulation resistance
- Excellent SMD handling
- RoHS-compatible

Applications

- DSL line card
- Telecommunication
- Applications with limited space

Electrical specifications

| Feature                                      | DC spark-over voltage | Impulse spark-over voltage | Service life | Insulation resistance at 100 V<sub>DC</sub> | Capacitance at 1 MHz | Arc voltage at 1 A | Glow to arc transition current | Glow voltage at 0.1 A | Weight | Operation and storage temperature | Climatic category (IEC 60068-1) | Marking |
|----------------------------------------------|-----------------------|----------------------------|--------------|---------------------------------------------|----------------------|-----------------------------|------------------------|--------|-----------------------------------|----------------------------------|---------|
| Tolerance                                    | 420 V                 | < 850 V                    | 2 A          | > 1 GΩ                                      | < 1.0 pF             | ~ 10 V                      | ~ 0.5 V                | ~ 60 V | 40 ... +125 °C                     | 40/125/21                         | without |
| Min.                                         | −15 ... +33 %         | < 750 V                    | 10/20 μs     |                                             |                      |                            |                        |        |                                   |                                  |         |
| Max.                                         | 360 V                 | < 1000 V                   | 100/200 μs   |                                             |                      |                            |                        |        |                                   |                                  |         |
| Min.                                         | 560 V                 | < 920 V                    | 5/320 μs     |                                             |                      |                            |                        |        |                                   |                                  |         |
| Min.                                         |                         |                            |              |                                             |                      |                            |                        |        |                                   |                                  |         |

1) At delivery AQL 0.65 level II, DIN ISO 2859
2) In ionized mode
3) Tip or ring electrode to center electrodes
4) Total current through center electrodes, half value through tip respectively ring electrode.
5) Tip to center electrode additional ring to center electrode
6) Test generator 6 kV, 10/700 μs, 40 Ω
Terms in accordance with ITU-T Rec. K.12 and IEC 61643-311.
Dimensional drawing in mm

![Dimensional drawing diagram]

Ordering code and packing advice

*B88069X5433T203* = SMD-tape with 2000 pcs.

SMD-tape according to IEC 60286-3
Soldering parameter

Reflow soldering

Surface mounted components (SMD) may exhibit a temporary increase in the DC spark-over voltage after the solder reflow process. The components will recover within 24 hours. There is no quality defect nor change in protection levels during the temporary change in DC spark-over voltage.

Cautions and warnings

- Do not operate surge arresters in power supply networks, whose maximum operating voltage exceeds the minimum spark-over voltage of the surge arresters.
- Surge arresters may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
- Surge arresters must be handled with care and must not be dropped.
- Do not continue to use damaged surge arresters.
- The shown SMD pad dimensions represent a safe way to mount the arrester and are a recommendation of the manufacturer. During the reflow process it must be assured that no solder material reduces the insulation distance between the pads below the arrester.
- SMD surge arresters should be soldered within 24 month after shipment.

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